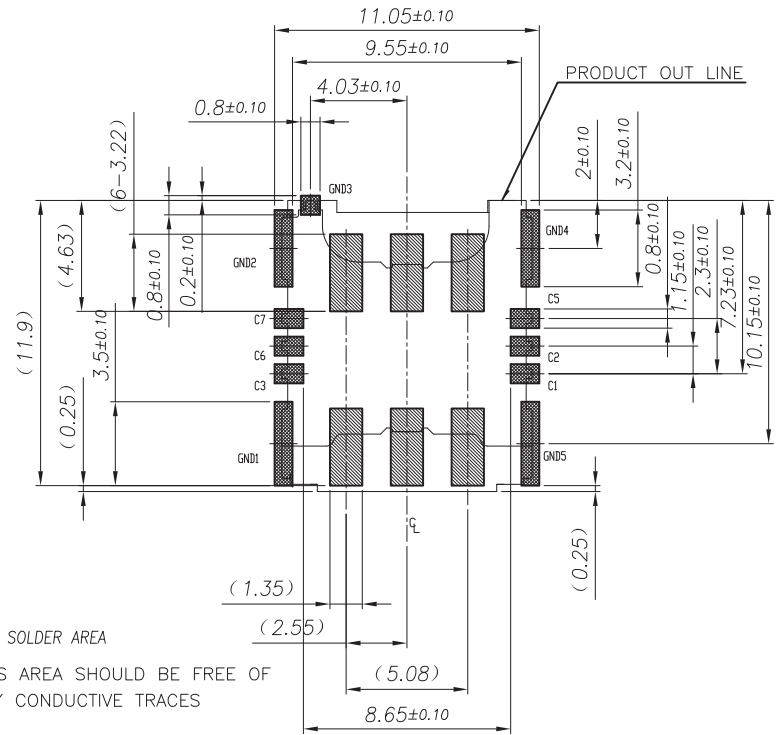


PIN NO.	NAME
C 1	VCC
C 2	RST
C 3	CLK
C 5	GND
C 6	VPP
C 7	I/O

NANO SIM CARD ASSIGNMENT

NOTES:

- MATERIAL:SEE TABLE
- SPECIALITY:
  - Rated current: 0.5A Max
  - Rated voltage: 30V AC
  - Contact Resistance:100mohm MAX
  - Insulation Resistance:1000Mohm MIN 500V DC
  - Dielectric withstanding voltage: 500V AC/minute.
  - Solder ability:250±5 10±0.5s.
  - Durability:5000 Cycles
  - Mating and Unmating force  
Insertion Force 10N Max  
Withdrawal Fore 0.5N Min



RECOMMENDED PCB LAYOUT TOP VIEW (TOLERANCE:±0.05)  
RECOMMENDED MATAL MASK T=0.12MM

ITEM	DESCRIPTION	MATERIAL	FINSH	Q'TY
3	TERMINAL	COPPER ALLOY	GOLD PLATING ON CONTACT AREA SEE PLATING CODE NOTE; GOLD PLATING 0.05um ON SOLDERTAIL AREA; ALL OVER 2~4um NICKEL	6
2	SHELL	STAINLESS STEEL	GOLD PLATING 0.05um MIN ON SOLDERTAIL AREA ALL OVER 2~4um Ni . SUS301-H T=0.10mm	1
1	HOUSING	HIGH TEMP. THERMOPLASTIC	GLASS FILLED (OR EQUAL),UL 94V-0, BLACK,NO RECYCLED RESIN.	1

RoHS Compliant

TOLERANCES ARE

**MORETHANALL**  
PCB CONNECTORS  
Cable ASSEMBLIES  
**煜倫股份有限公司**

DRAWING BY CY

CHECKED BY GENIUS

UNIT / mm

SCALE 1 : 1

DATE

SIZE A4

X. ± 0.50

.X ± 0.20

.XX ± 0.10

.XXX ±

ANG ± 1°

PPOJECTION

照片框

ORDER INFORMATION

NASCT-W0911X-06-LF

SERIES

LEADFREE

06WAY

NON POST

HIGH 1.12mm

PAD TO PAD 9.55mm

90°SMT

DESCRIPTION: 6Pin 1.12H PUSH PULL Nano SIM CARD CONN.

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